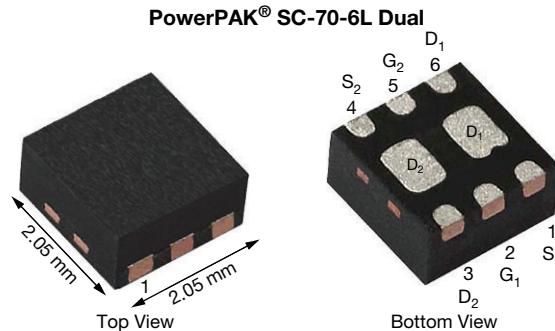


N- and P-Channel 12 V (D-S) MOSFET



Marking code: EH

PRODUCT SUMMARY		
	N-CHANNEL	P-CHANNEL
V _{DS} (V)	12	-12
R _{DS(on)} (Ω) at V _{GS} = \pm 4.5 V	0.034	0.059
R _{DS(on)} (Ω) at V _{GS} = \pm 2.5 V	0.040	0.081
R _{DS(on)} (Ω) at V _{GS} = \pm 1.8 V	0.050	0.115
R _{DS(on)} (Ω) at V _{GS} = \pm 1.5 V	0.070	0.215
Q _g typ. (nC)	5.6	7.8
I _D (A) ^a	4.5	-4.5
Configuration	N- and p-pair	

FEATURES

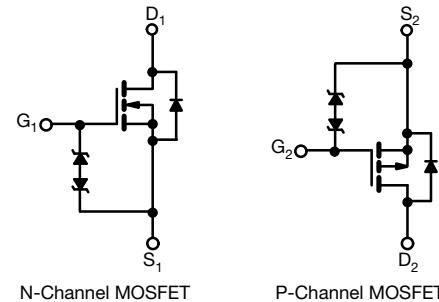
- TrenchFET® power MOSFETs
- Typical ESD protection:
n-channel 1500 V, p-channel 1000 V
- 100 % R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Load switch for portable devices
- DC/DC converters



ORDERING INFORMATION

Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA533EDJ-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)				
PARAMETER	SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Drain-source voltage	V _{DS}	12	-12	V
Gate-source voltage	V _{GS}	\pm 8	\pm 8	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C	I _D	4.5 ^a	-4.5 ^a
	T _C = 70 °C		4.5 ^a	-4.5 ^a
	T _A = 25 °C		4.5 ^{a, b, c}	-4.5 ^{a, b, c}
	T _A = 70 °C		4.5 ^{a, b, c}	-3.7 ^{b, c}
Pulsed drain current	I _{DM}	20	-15	A
Source-drain current diode current	T _C = 25 °C	I _S	4.5 ^a	-4.5 ^a
	T _A = 25 °C		1.6 ^{b, c}	-1.6 ^{b, c}
Maximum power dissipation	T _C = 25 °C	P _D	7.8	7.8
	T _C = 70 °C		5	5
	T _A = 25 °C		1.9 ^{b, c}	1.9 ^{b, c}
	T _A = 70 °C		1.2 ^{b, c}	1.2 ^{b, c}
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150		°C
Soldering recommendations (peak temperature) ^{d, e}		260		

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	N-CHANNEL		P-CHANNEL		UNIT	
		TYP.	MAX.	TYP.	MAX.		
Maximum junction-to-ambient b, f	t ≤ 5 s	R _{thJA}	52	65	52	65	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	12.5	16	12.5	16	

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 110 °C/W

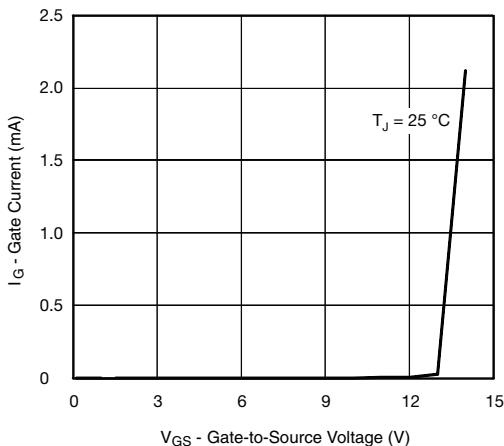
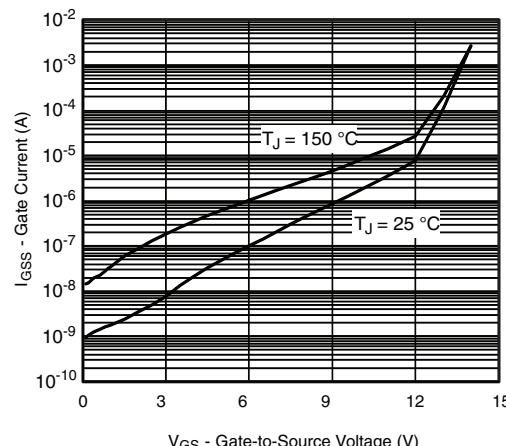
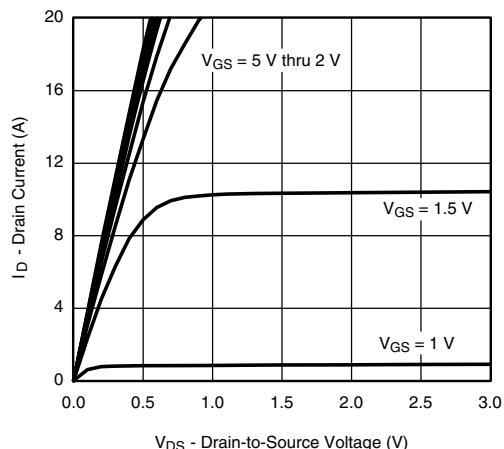
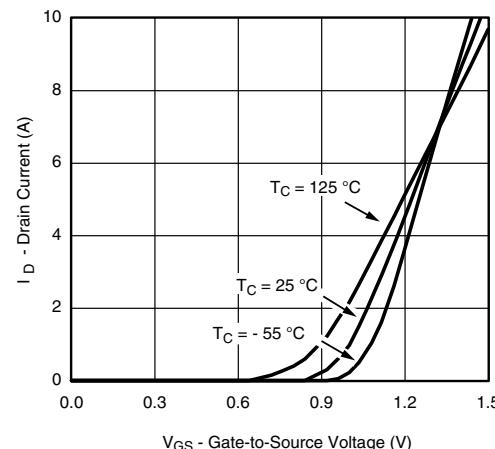
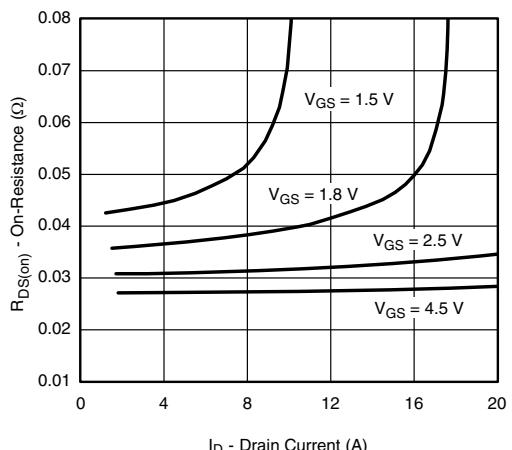
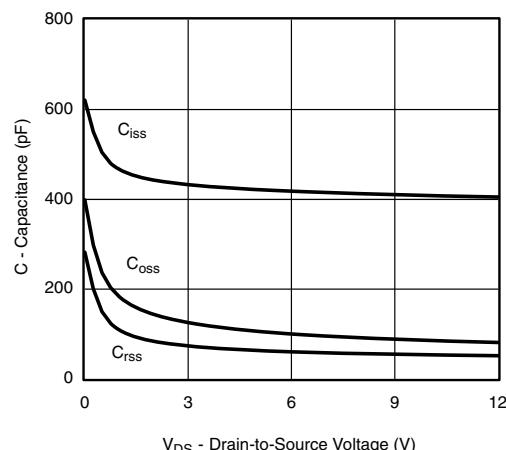
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	N-Ch	12	-	-	-	V
		V _{GS} = 0 V, I _D = -250 μA	P-Ch	-12	-	-	-	
V _{DS} temperature coefficient	ΔV _{DS} /T _J	I _D = 250 μA	N-Ch	-	19	-	-	mV/°C
		I _D = -250 μA	P-Ch	-	-5.7	-	-	
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA	N-Ch	-	-2.7	-	-	
		I _D = -250 μA	P-Ch	-	1.7	-	-	
Gate threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	N-Ch	0.4	-	1	-	V
		V _{DS} = V _{GS} , I _D = -250 μA	P-Ch	-0.4	-	-1	-	
Gate-body leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 4.5 V	N-Ch	-	-	± 0.5	-	μA
			P-Ch	-	-	± 0.5	-	
		V _{DS} = 0 V, V _{GS} = ± 8 V	N-Ch	-	-	± 5	-	
			P-Ch	-	-	± 5	-	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 12 V, V _{GS} = 0 V	N-Ch	-	-	1	-	
		V _{DS} = -12 V, V _{GS} = 0 V	P-Ch	-	-	-1	-	
		V _{DS} = 12 V, V _{GS} = 0 V, T _J = 55 °C	N-Ch	-	-	10	-	
		V _{DS} = -12 V, V _{GS} = 0 V, T _J = 55 °C	P-Ch	-	-	-10	-	
On-state drain current ^b	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 4.5 V	N-Ch	10	-	-	-	A
		V _{DS} ≤ -5 V, V _{GS} = -4.5 V	P-Ch	-10	-	-	-	
Drain-source on-state resistance ^b	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 4.6 A	N-Ch	-	0.028	0.034	-	Ω
		V _{GS} = -4.5 V, I _D = -3.6 A	P-Ch	-	0.048	0.059	-	
		V _{GS} = 2.5 V, I _D = 4.2 A	N-Ch	-	0.032	0.040	-	
		V _{GS} = -2.5 V, I _D = -3.1 A	P-Ch	-	0.066	0.081	-	
		V _{GS} = 1.8 V, I _D = 3.8 A	N-Ch	-	0.038	0.050	-	
		V _{GS} = -1.8 V, I _D = -2.6 A	P-Ch	-	0.093	0.115	-	
		V _{GS} = 1.5 V, I _D = 1.5 A	N-Ch	-	0.045	0.070	-	
		V _{GS} = -1.5 V, I _D = -0.5 A	P-Ch	-	0.120	0.215	-	
Forward transconductance ^b	g _{fs}	V _{DS} = 6 V, I _D = 4.6 A	N-Ch	-	21	-	-	S
		V _{DS} = -6 V, I _D = -3.6 A	P-Ch	-	11	-	-	

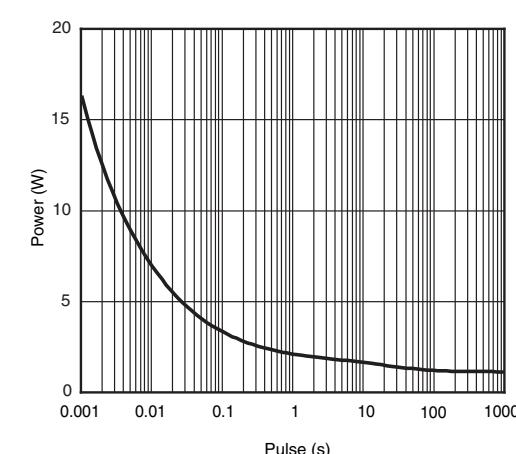
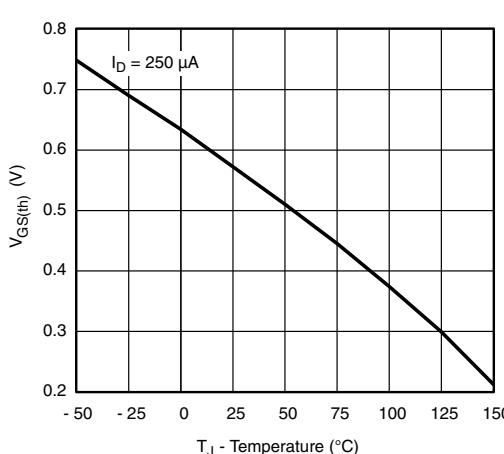
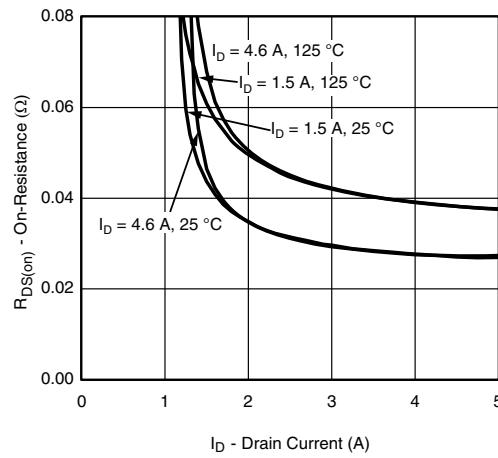
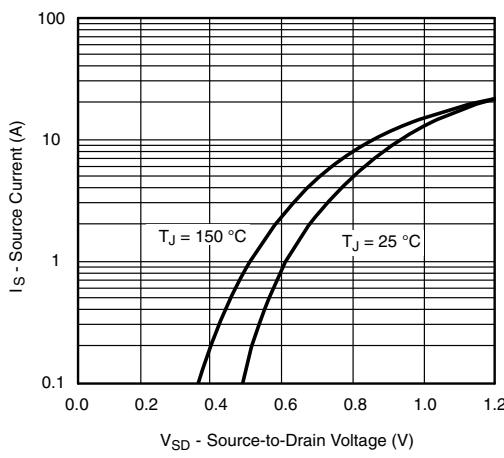
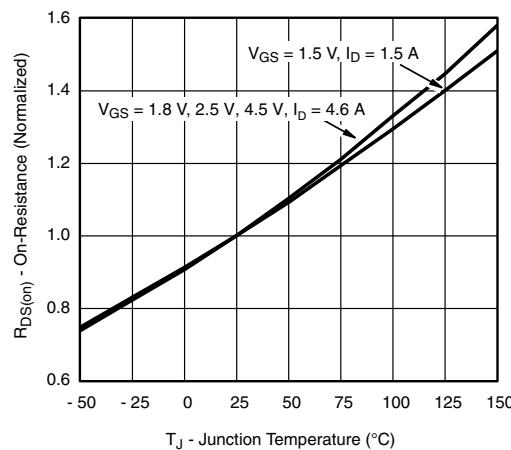
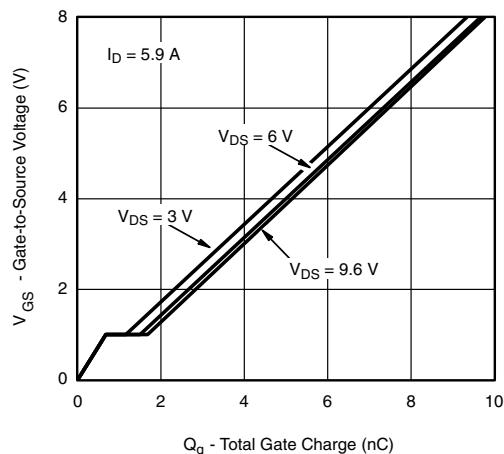
SPECIFICATIONS ($T_J = 25^\circ\text{C}$, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT
Dynamic ^a								
Input capacitance	C_{iss}	N-channel $V_{DS} = 6 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$ P-channel $V_{DS} = -6 \text{ V}$, $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$	N-Ch	-	420	-	pF	
Output capacitance	C_{oss}		P-Ch	-	545	-		
Reverse transfer capacitance	C_{rss}		N-Ch	-	100	-		
			P-Ch	-	192	-		
			N-Ch	-	62	-		
			P-Ch	-	175	-		
Total gate charge	Q_g	$V_{DS} = 10 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 5.9 \text{ A}$	N-Ch	-	10	15	nC	
		$V_{DS} = -10 \text{ V}$, $V_{GS} = -10 \text{ V}$, $I_D = -4.7 \text{ A}$	P-Ch	-	13	20		
		$V_{DS} = 10 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 5.9 \text{ A}$	N-Ch	-	5.6	8.5		
		$V_{DS} = -10 \text{ V}$, $V_{GS} = -4.5 \text{ V}$, $I_D = -4.7 \text{ A}$	P-Ch	-	7.8	12		
Gate-source charge	Q_{gs}	N-channel $V_{DS} = 10 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 5.9 \text{ A}$ P-channel $V_{DS} = -10 \text{ V}$, $V_{GS} = -4.5 \text{ V}$, $I_D = -4.7 \text{ A}$	N-Ch	-	0.7	-	nC	
Gate-drain charge	Q_{gd}		P-Ch	-	1.3	-		
Gate resistance	R_g		N-Ch	-	0.85	-		
			P-Ch	-	2.3	-		
Turn-on delay time	$t_{d(on)}$	N-channel $V_{DD} = 6 \text{ V}$, $R_L = 1.3 \Omega$, $I_D \geq 4.8 \text{ A}$, $V_{GEN} = 4.5 \text{ V}$, $R_g = 1 \Omega$ P-channel $V_{DD} = -6 \text{ V}$, $R_L = 1.6 \Omega$, $I_D \geq -3.7 \text{ A}$, $V_{GEN} = -4.5 \text{ V}$, $R_g = 1 \Omega$	N-Ch	0.7	3.5	7	Ω	
Rise time	t_r		P-Ch	1.4	7	14		
Turn-off delay time	$t_{d(off)}$		N-Ch	-	10	15		
Fall time	t_f		P-Ch	-	10	15		
Turn-on delay time	$t_{d(on)}$		N-Ch	-	5	10		
Rise time	t_r		P-Ch	-	5	10		
Turn-off delay time	$t_{d(off)}$		N-Ch	-	10	15		
Fall Time	t_f		P-Ch	-	10	15		
Drain-Source Body Diode Characteristics								
Continuous source-drain diode current	I_S	$T_C = 25^\circ\text{C}$	N-Ch	-	-	4.5	A	
Pulse diode forward current ^a	I_{SM}		P-Ch	-	-	-4.5		
Body diode voltage	V_{SD}	$I_S = 4.8 \text{ A}$, $V_{GS} = 0 \text{ V}$	N-Ch	-	0.85	1.2	V	
		$I_S = -3.7 \text{ A}$, $V_{GS} = 0 \text{ V}$	P-Ch	-	-0.87	-1.2		
Body diode reverse recovery time	t_{rr}	N-channel $I_F = 4.4 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$ P-channel $I_F = -3.7 \text{ A}$, $dI/dt = -100 \text{ A}/\mu\text{s}$, $T_J = 25^\circ\text{C}$	N-Ch	-	10	20	ns	
Body diode reverse recovery charge	Q_{rr}		P-Ch	-	25	50		
Reverse recovery fall time	t_a		N-Ch	-	5	10	nC	
Reverse recovery rise time	t_b		P-Ch	-	10	20		
			N-Ch	-	5.5	-	ns	
			P-Ch	-	17	-		
			N-Ch	-	4.5	-		
			P-Ch	-	8	-		

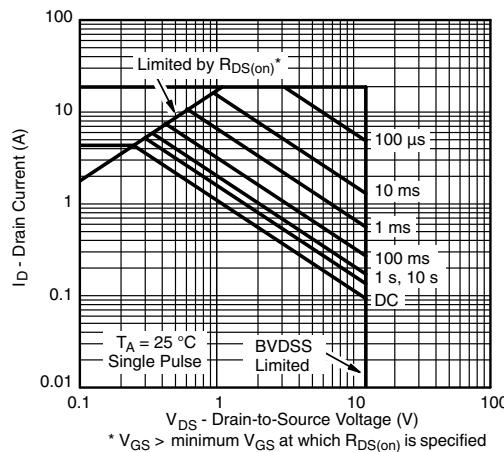
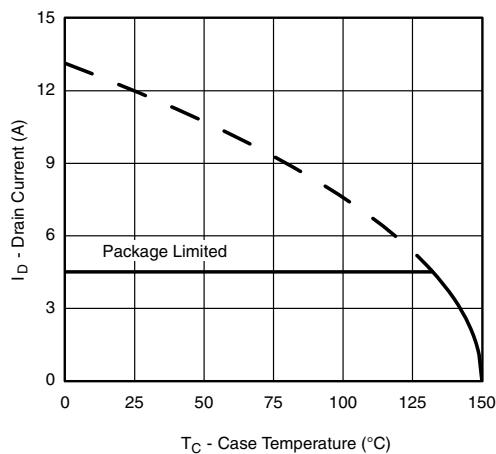
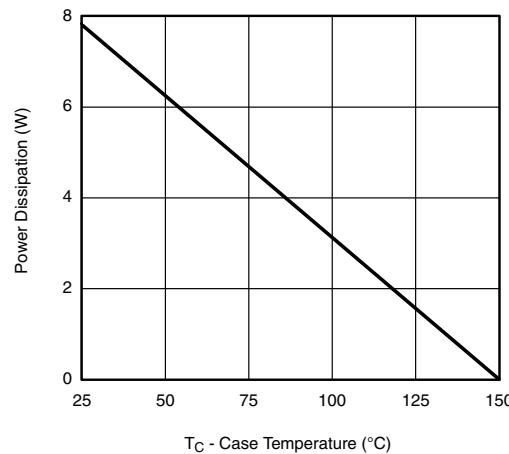
Notes

- a. Guaranteed by design, not subject to production testing
- b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2 \%$

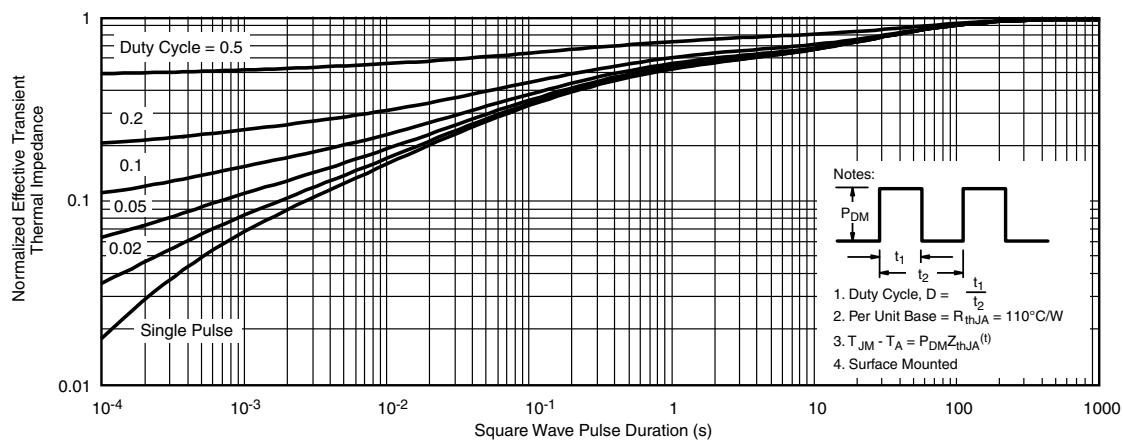
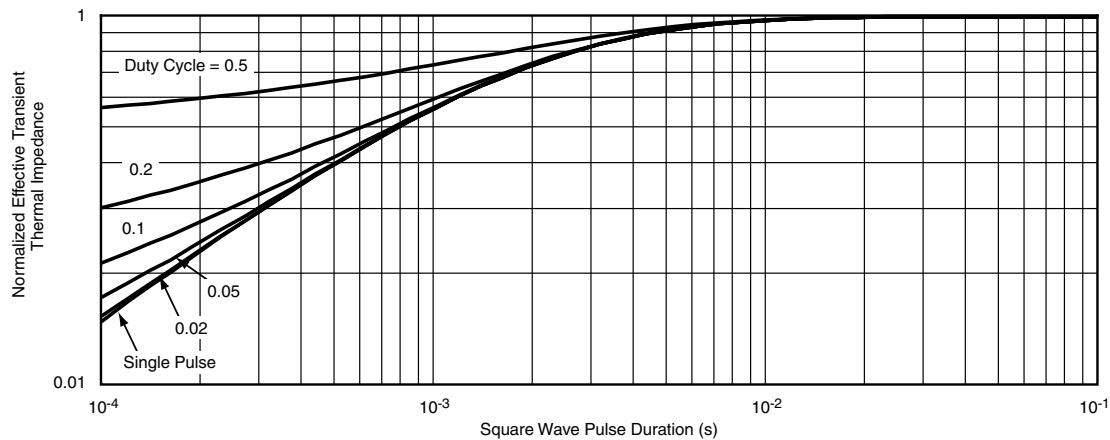
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

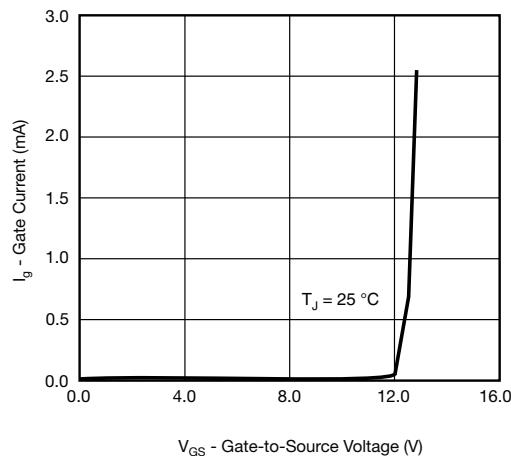
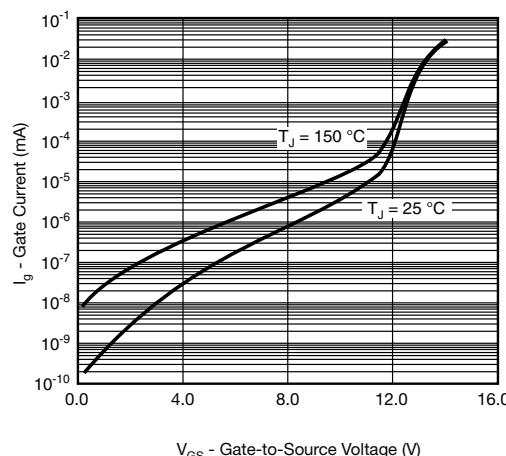
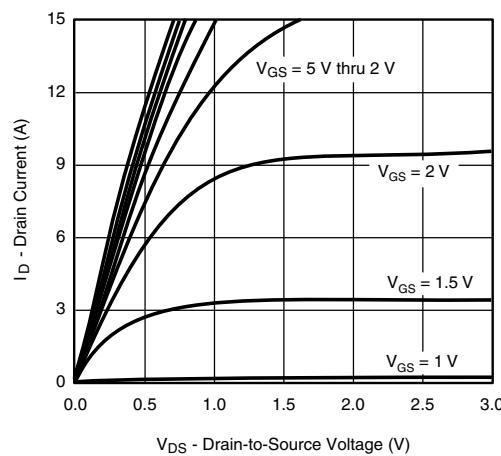
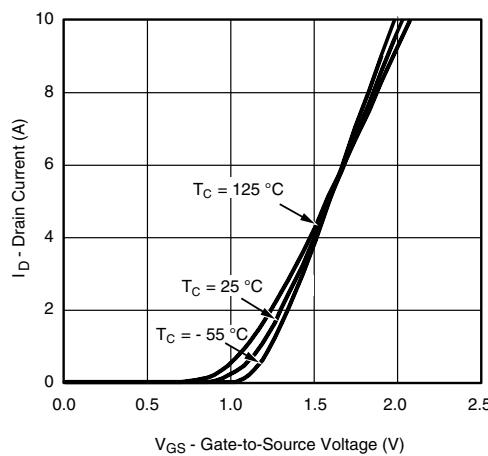
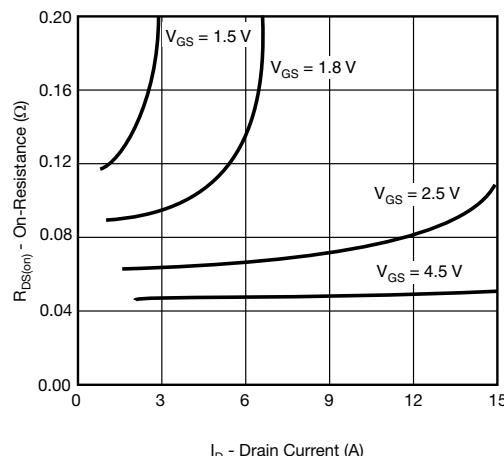
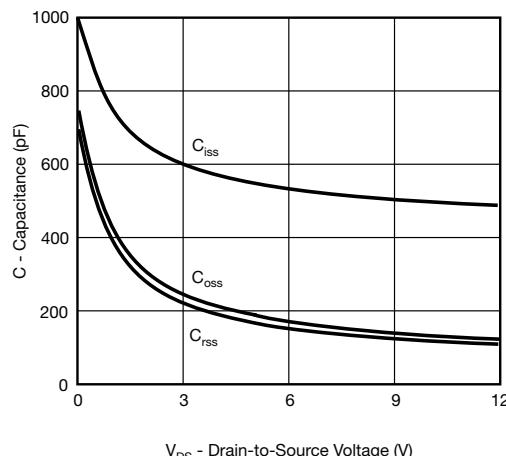
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Gate Current vs. Gate-Source Voltage

Gate Current vs. Gate-Source Voltage

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current and Gate Voltage

Capacitance

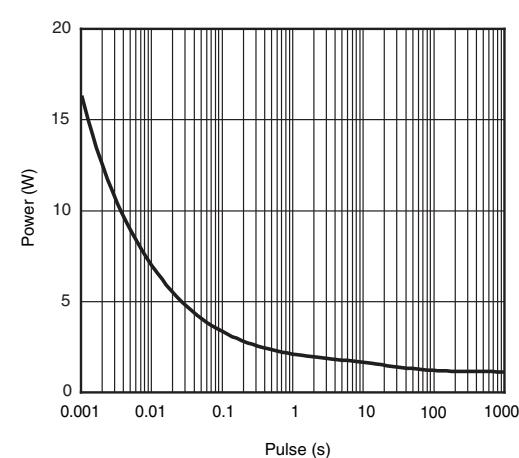
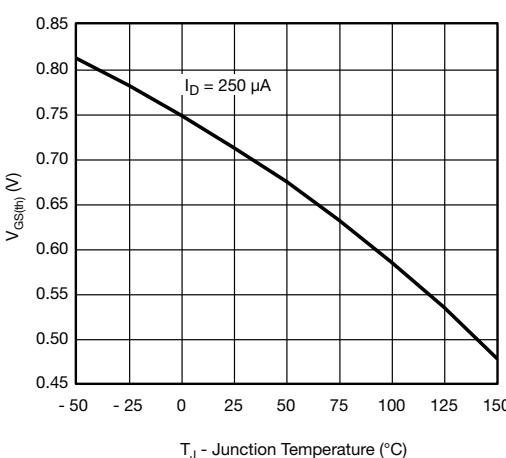
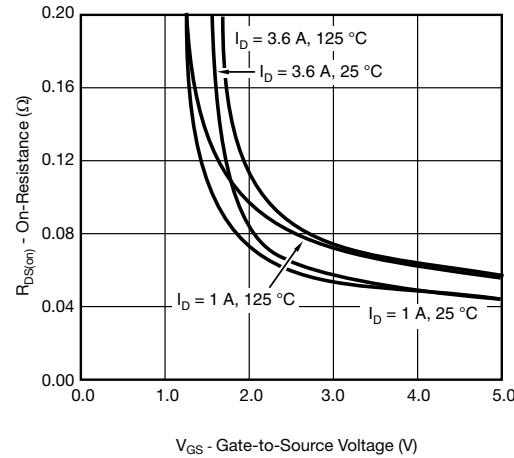
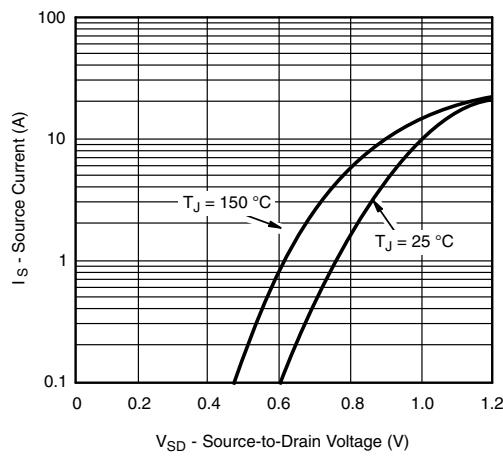
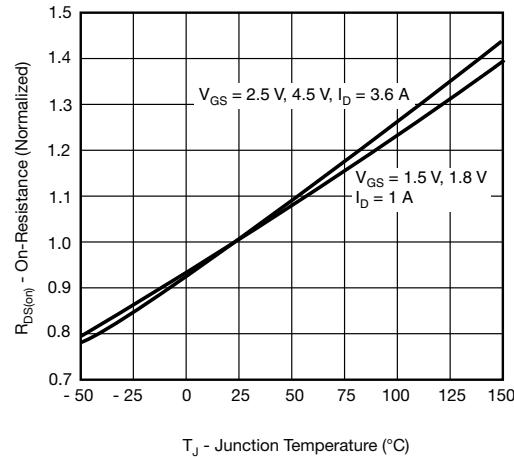
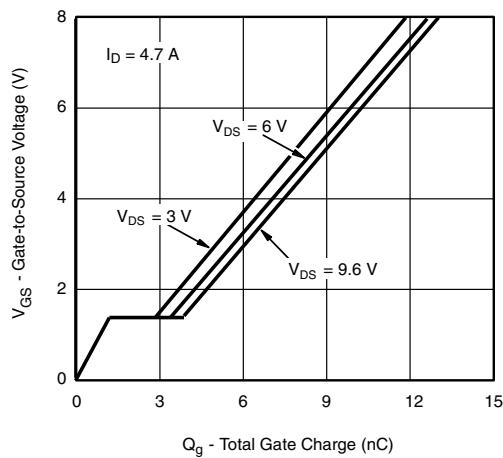
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


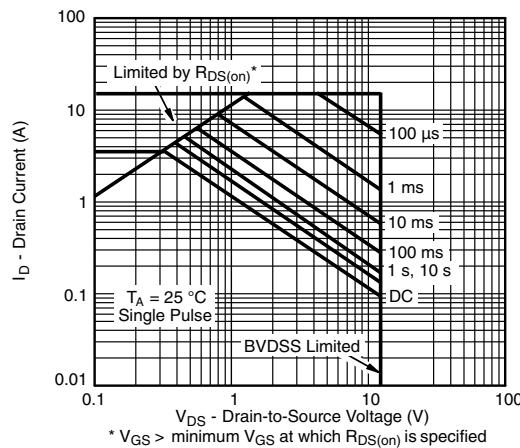
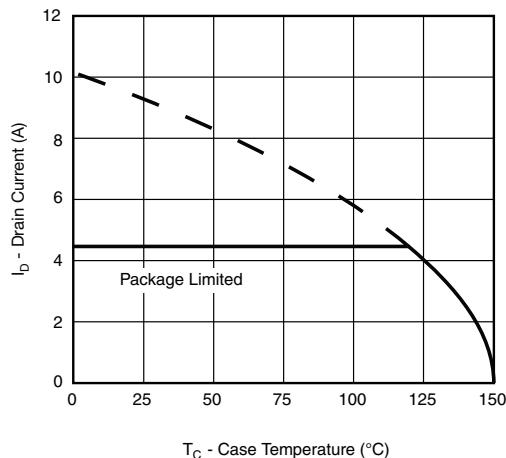
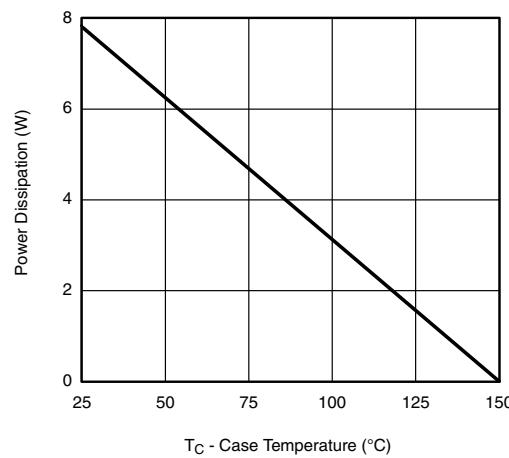
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Safe Operating Area, Junction-to-Ambient

Current Derating ^a

Power Derating
Note

- The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

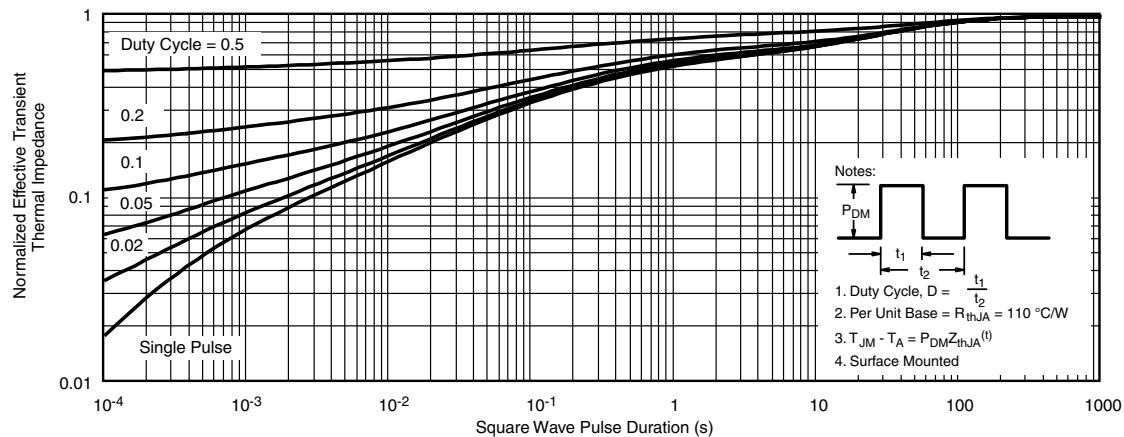
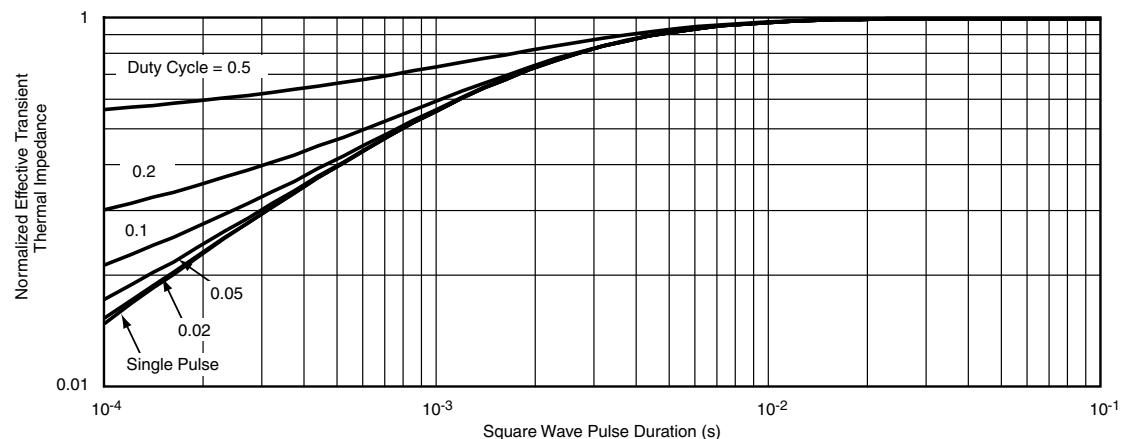
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Case

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Gate Current vs. Gate-Source Voltage

Gate Current vs. Gate-Source Voltage

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current and Gate Voltage

Capacitance

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


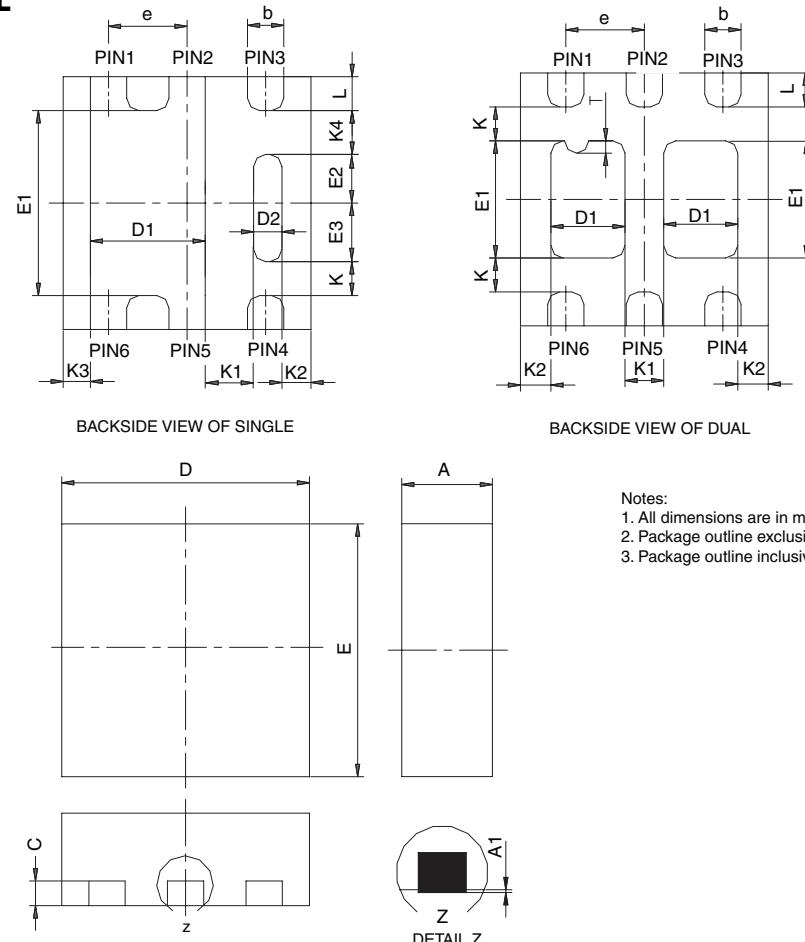
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Safe Operating Area, Junction-to-Ambient

Current Derating ^a

Power Derating
Note

- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Ambient

Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65706.

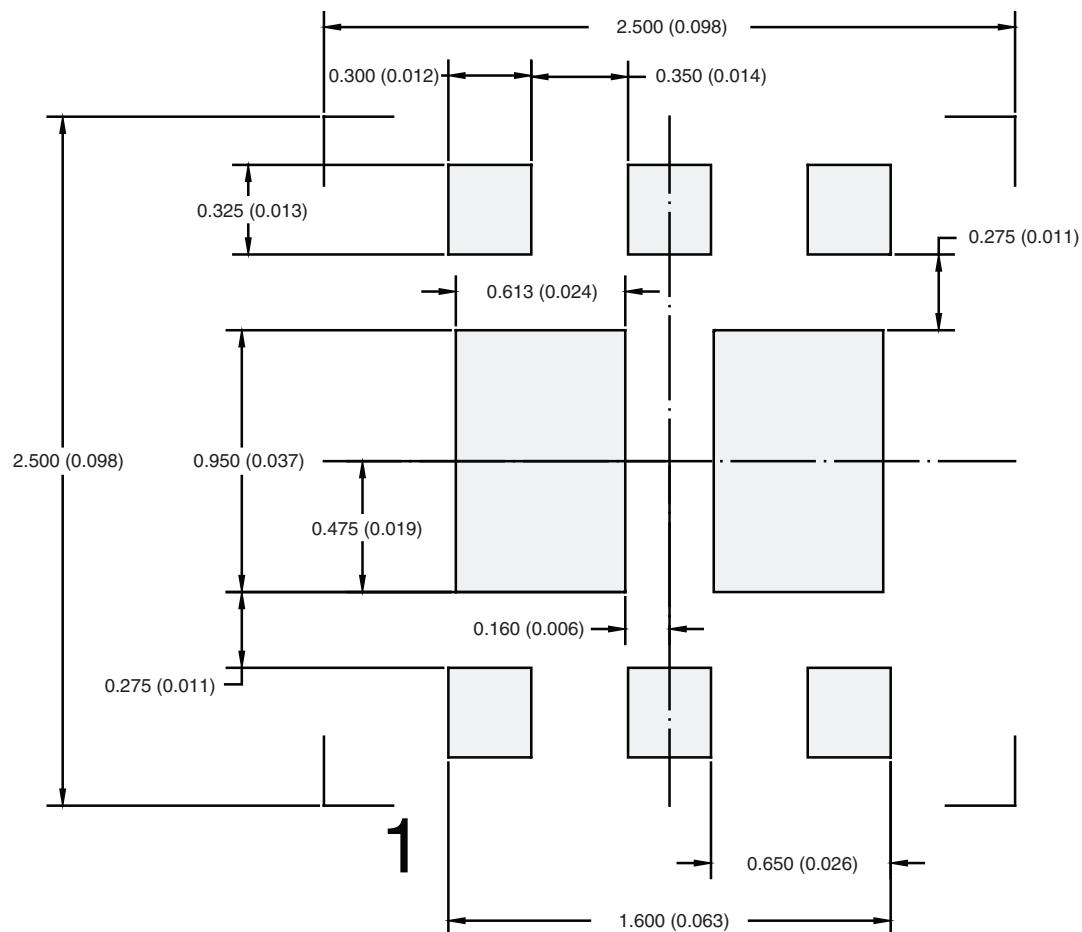
PowerPAK® SC70-6L



DIM	SINGLE PAD						DUAL PAD					
	MILLIMETERS			INCHES			MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max
A	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015
C	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028
D2	0.135	0.235	0.335	0.005	0.009	0.013						
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041
E2	0.345	0.395	0.445	0.014	0.016	0.018						
E3	0.425	0.475	0.525	0.017	0.019	0.021						
e	0.65 BSC			0.026 BSC			0.65 BSC			0.026 BSC		
K	0.275 TYP			0.011 TYP			0.275 TYP			0.011 TYP		
K1	0.400 TYP			0.016 TYP			0.320 TYP			0.013 TYP		
K2	0.240 TYP			0.009 TYP			0.252 TYP			0.010 TYP		
K3	0.225 TYP			0.009 TYP								
K4	0.355 TYP			0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015
T							0.05	0.10	0.15	0.002	0.004	0.006

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RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

APPLICATION NOTE

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